# LME49600 Headphone Amplifier Evaluation Board User's Guide

#### **Quick Start Guide**

Apply a  $\pm 2.5V$  to  $\pm 17V$  power supply's voltage to the respective "V+", "GND" and "V-" pins on JU19

Apply a stereo audio signal to the RCA jacks J1 (Right) and J2 (Left) or jumpers JU1 (Right) and JU17 (Left), observing the signal input pin and the ground (GND) pin. Though not typically installed, a stereo signal can also be applied to head-phone jack HPJ1.

Connect a load to JU14 (Left) and another load to JU15 (Right), observing the signal output pin and the ground (GND) pin. The stereo signal output is also available on the 1/8" stereo headphone jack located in the board's "OUTPUT" section

National Semiconductor Application Note 1768 Kevin Hoskins February 29, 2008



Use VR1 to control the output signal amplitude.

Apply power. Make measurements. Plug in a pair of headphones. Enjoy.

### Introduction

To help the user investigate and evaluate the LME49600's performance and capabilities, a fully populated demonstration board was created. Please contact the National Semiconductor Corporation's Audio Products Group for availability. This board is shown in Figure 1. Connected to an external power supply ( $\pm 2.5V$  to  $\pm 17V$ ) and a signal source. The LME49600 demonstration board easily demonstrates the amplifier's features.



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FIGURE 1. The LME49600/LME49720 Stereo Headphone Amplifier Demonstration Board

#### **General Description**

The LME49600 is a high performance, low distortion high fidelity 250mA audio buffer. Whereas there are many uses for the LME49600, this application note describes a headphone amplifier circuit and associated demonstration board. Designed for use inside an operational amplifier's feedback loop, it increases output current, improves capacitive load drive, and eliminates thermal feedback.

The LME49600 offers a pin-selectable bandwidth: a low current, 110MHz bandwidth mode that consumes 8mA and a wide 180MHz bandwidth mode that consumes 15mA. In both modes the LME49600 has a nominal 2000V/ $\mu$ s slew rate. Bandwidth is easily adjusted by either leaving the BW pin unconnected, connecting a resistor between the BW pin and the V<sub>EE</sub> pin or connecting the BW pin directly to the V<sub>EE</sub> pin.

The LME49600 is fully protected through internal current limit and thermal shutdown.

## **Operating Conditions**

- Temperature Range  $-40^{\circ}C \le T_A \le 85^{\circ}C$
- Amplifier Power Supply Voltage  $2.5V \le V_S \pm 17V$

#### **Board Features**

The LME49600/LME49720 Stereo Headphone Amplifier demonstration board has all of the necessary connections, using RCA jacks, 1/8" stereo headphone jack and 0.100" headers, to apply the power supply voltage and the audio input signals. The amplified audio signal is available on both a stereo headphone jack and auxiliary output connections.

Also present on the demonstration board is a potentiometer to control the stereo output signal magnitude.

#### Schematic

Figure 2 shows the LME49600/LME49720 Stereo Headphone Amplifier Demonstration Board schematic. Refer to Table 3 for a list of the connections and their functions.



#### Connections

Connecting to the world is accomplished through a combination of RCA jacks, 1/8" stereo headphone jacks and 0.100"

headers on the LME49600 demonstration board. The func-tions of the different headers, 1/8" headphone jacks are detailed in Table 1.

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Designator	Function or Use		
JU17	This is the connection to the amplifier's left channel input. Apply an external signal source's positive voltage to the JU17 pin labeled "LT IN" and the signal source's ground signal to the pin labeled "GND."		
J2	This is an RCA connector that parallels the pins on JU17.		
HPJ1	Stereo, 1/8" headphone jack. Used for stereo signal input. Left channel input is on the tip connector and the right channel input is on the ring connector. Ground is on the sleeve connector.		
J1	This is an RCA connector that parallels the pins on JU1.		
JU1	This is the connection to the amplifier's right channel input. Apply an external signal source's positive voltage to the JU1 pin labeled "RT IN" and the signal source's ground signal to the pin labeled "GND."		
JU19	Power supply connection. Connect an external split power supply's voltage source $\pm 2.5V$ to $\pm 17V$ to the JU19 pin labeled ("V+" and "V-")" and the supply's ground source to the pin labeled "GND."		
JU14	This is the connection to the amplifier's single-ended, ground-referenced left channel output. Connect the JU14 pin labeled "LT OUT" and the pin labeled "GND" to the positive and ground inputs, respectively, of an external signal measurement device. JU14's pin labeled "LT OUT" corresponds to the headphone jack's "tip" connection. J5's pin labeled "GND" corresponds to the headphone jack's "sleeve" (or ground) connection.		
HPJ2	Stereo, 1/8" headphone jack. Used for stereo signal output. Left channel output is on the tip connector and the right channel output is on the ring connector. Ground is on the sleeve connector.		
JU15	This is the connection to the amplifier's ground-referenced right channel output. Connect the JU15 pin labeled "RT OUT" and the pin labeled "GND" to the positive and ground inputs, respectively, of an external signal measurement device. JU15's pin labeled "RT OUT" corresponds to the headphone jack's "ring" connection. J4's pin labeled "GND" corresponds to the headphone jack's "sleeve" (or ground) connection.		
JU4, JU6	These connections allow monitoring the left and right channel DC servo outputs, respectively.		

### **PCB Layout Guidelines**

POWER AND GROUND CIRCUITS

This section provides general practical guidelines for PCB layouts that use various power and ground traces. Designers should note that these are only "rule-of-thumb" recommendations and the actual results are predicated on the final layout.

Star trace routing techniques can have a major positive impact on low-level signal performance. Star trace routing refers to using individual traces that radiate from a signal point to feed power and ground to each circuit or even device.

# **Bill of Materials**

RefDes	Part Description	Value	Tolerance	Rating	Package	Manufacturer
					Туре	and Part Number
BAT1_BAT2	9V Battery Terminal (male &					KEYSTONE
DATI- DATZ	female) [Not Installed]					593 (Female) & 594 (Male)
C1 C0	MULITYLAYER CERAMIC	1.0µF	±20%	25V	805	TDK
/1 - 00	CAPACITOR					C2012X5R1E105M
C9 C10, C23 – C24	TANTALUM ELECTROLYTIC CAPACITOR	4.7.5	±10%	35V	B CASE	AVX
		4.7μF				TPSB475K035R0700
010 014		00 -	000/	051/		AVX
012, 014		ZZHF	±20%	237	CCASE	TPSD226M025#011
C10 C22	CERAMIC CAPACITOR	0.4	±10%	25V	603	ТDК
019-022		0.1μ-				C1608X7R1E104K
HPJ1– HPJ2	1/8" Stereo Headphone Jack					
J1 – J2	RCA jack					
JU1, JU4, JU6,	100mil pin pitch, two pin					
JU14, JU15, JU17						
JU19	100mil pin pitch, three pin					
	1/4W resistor	1kΩ	±1%	1/4W	1/4W, Axial	YAGEO
n i – no						MFR-25FBF-1K00
	1/4W resistor	1MΩ	±1%	1/4W	1/4W, Axial	YAGEO
N9 - N12						MFR-25FBF-1M00
C1	SWITCH SLIDE DPDT					
51	[Not Installed]					
	LME49720NA (Can also use					National Semiconductor Corp.
U1, U2						LME49720NA
						(LM4562NA or LME49860NA)
113 114	LME49600					National Semiconductor Corp.
						LME49600TS
VB1	Dual gauged potentiomator	1040				PANASONIC
		10002				EVJ-Y00F30A14

#### **Demonstration Board PCB Layout**

Figures 3 through 6 show the different layers used to create the LME49600 demonstration board. Figure 3 is the

silkscreen that shows parts location. Figure 4 is the top layer. Figure 5 is the bottom layer. Figure 6 is the bottom silkscreen layer.



Figure 3. Top Silkscreen



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Figure 5. Bottom Layer



Figure 6. Bottom Silk Layer



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	Revision History							
ſ	Rev	Date	Description					
[	1.0	02/29/08	Initial release.					

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# Notes

Products		Design Support			
Amplifiers	www.national.com/amplifiers	WEBENCH	www.national.com/webench		
Audio	www.national.com/audio	Analog University	www.national.com/AU		
Clock Conditioners	www.national.com/timing	App Notes	www.national.com/appnotes		
Data Converters	www.national.com/adc	Distributors	www.national.com/contacts		
Displays	www.national.com/displays	Green Compliance	www.national.com/quality/green		
Ethernet	www.national.com/ethernet	Packaging	www.national.com/packaging		
Interface	www.national.com/interface	Quality and Reliability	www.national.com/quality		
LVDS	www.national.com/lvds	Reference Designs	www.national.com/refdesigns		
Power Management	www.national.com/power	Feedback	www.national.com/feedback		
Switching Regulators	www.national.com/switchers				
LDOs	www.national.com/ldo				
LED Lighting	www.national.com/led				
PowerWise	www.national.com/powerwise				
Serial Digital Interface (SDI)	www.national.com/sdi				
Temperature Sensors	www.national.com/tempsensors				
Wireless (PLL/VCO)	www.national.com/wireless				

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